

MM74HCU04 Hex Inverter

Features

- Typical propagation delay: 7ns
- Fanout of 15 LS-TTL loads
- Quiescent power consumption: 10µA maximum at room temperature
- Low input current: 1µA maximum

General Description


The MM74HCU04 inverters utilize advanced silicon-gate CMOS technology to achieve operating speeds similar to LS-TTL gates with the low power consumption of standard CMOS integrated circuits.

The MM74HCU04 is an unbuffered inverter. It has high noise immunity and the ability to drive 15 LS-TTL loads. The 74HCU logic family is functionally as well as pin-out compatible with the standard 74LS logic family. All inputs are protected from damage due to static discharge by internal diode clamps to V_{CC} and ground.

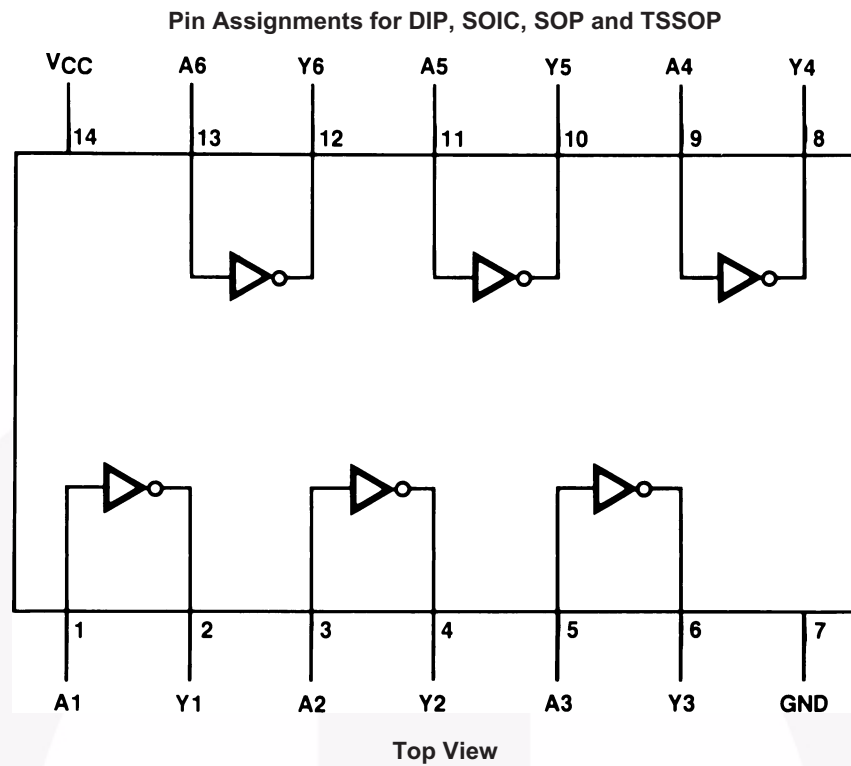
Ordering Information

Order Number	Package Number	Package Description
MM74HCU04M	M14A	14-Lead Small Outline Integrated Circuit (SOIC), JEDEC MS-012, 0.150" Narrow
MM74HCU04SJ	M14D	14-Lead Small Outline Package (SOP), EIAJ TYPE II, 5.3mm Wide
MM74HCU04MTC	MTC14	14-Lead Thin Shrink Small Outline Package (TSSOP), JEDEC MO-153, 4.4mm Wide
MM74HCU04N	N14A	14-Lead Plastic Dual-In-Line Package (PDIP), JEDEC MS-001, 0.300" Wide

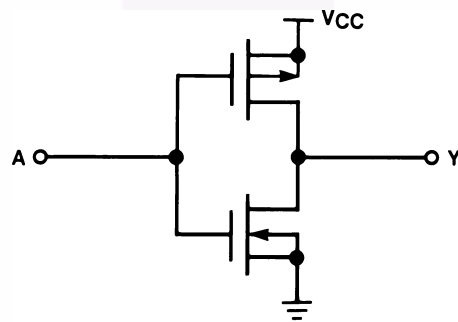
Device also available in Tape and Reel. Specify by appending suffix letter "X" to the ordering number.

 All packages are lead free per JEDEC: J-STD-020B standard.

Connection Diagram



Schematic Diagram



Absolute Maximum Ratings⁽¹⁾

Stresses exceeding the absolute maximum ratings may damage the device. The device may not function or be operable above the recommended operating conditions and stressing the parts to these levels is not recommended. In addition, extended exposure to stresses above the recommended operating conditions may affect device reliability. The absolute maximum ratings are stress ratings only.

Symbol	Parameter	Rating
V_{CC}	Supply Voltage	−0.5 to +7.0V
V_{IN}	DC Input Voltage	−1.5 to $V_{CC}+1.5V$
V_{OUT}	DC Output Voltage	−0.5 to $V_{CC}+0.5V$
I_{IK}, I_{OK}	Clamp Diode Current	±20mA
I_{OUT}	DC Output Current, per pin	±25mA
I_{CC}	DC V_{CC} or GND Current, per pin	±50mA
T_{STG}	Storage Temperature Range	−65°C to +150°C
P_D	Power Dissipation Note 2	600mW
	S.O. Package only	500mW
T_L	Lead Temperature (Soldering 10 seconds)	260°C

Notes:

1. Unless otherwise specified all voltages are referenced to ground.
2. Power Dissipation temperature derating — plastic “N” package: −12mW/°C from 65°C to 85°C.

Recommended Operating Conditions

The Recommended Operating Conditions table defines the conditions for actual device operation. Recommended operating conditions are specified to ensure optimal performance to the datasheet specifications. Fairchild does not recommend exceeding them or designing to absolute maximum ratings.

Symbol	Parameter	Min.	Max.	Units
V_{CC}	Supply Voltage	2	6	V
V_{IN}, V_{OUT}	DC Input or Output Voltage	0	V_{CC}	V
T_A	Operating Temperature Range	−40	+85	°C

DC Electrical Characteristics

Symbol	Parameter	V _{CC} (V)	Conditions	T _A = 25°C		T _A = −40°C to 85°C	T _A = −55°C to 125°C	Units
				Typ.	Guaranteed Limits			
V _{IH}	Minimum HIGH Level Input Voltage	2.0			1.7	1.7	1.7	V
		4.5			3.6	3.6	3.6	
		6.0			4.8	4.8	4.8	
V _{IL}	Maximum LOW Level Input Voltage	2.0			0.3	0.3	0.3	V
		4.5			0.8	0.8	0.8	
		6.0			1.1	1.1	1.1	
V _{OH}	Minimum HIGH Level Output Voltage	2.0	V _{IN} = V _{IL} , I _{OUT} ≤ 20μA	2.0	1.8	1.8	1.8	V
		4.5		4.5	4.0	4.0	4.0	
		6.0		6.0	5.5	5.5	5.5	
		4.5	V _{IN} = GND, I _{OUT} ≤ 4.0mA	4.2	3.98	3.84	3.7	
		6.0	V _{IN} = GND, I _{OUT} ≤ 5.2mA	5.7	5.48	5.34	5.2	
V _{OL}	Maximum LOW Level Output Voltage	2.0	V _{IN} = V _{IH} , I _{OUT} ≤ 20μA	0	0.2	0.2	0.2	V
		4.5		0	0.5	0.5	0.5	
		6.0		0	0.5	0.5	0.5	
		4.5	V _{IN} = V _{CC} , I _{OUT} ≤ 6.0mA	0.2	0.26	0.33	0.4	
		6.0	V _{IN} = V _{CC} , I _{OUT} ≤ 7.8mA	0.2	0.26	0.33	0.4	
I _{IN}	Maximum Input Current	6.0	V _{IN} = V _{CC} or GND		±0.1	±1.0	±1.0	μA
I _{CC}	Maximum Quiescent Supply Current	6.0	V _{IN} = V _{CC} or GND, I _{OUT} = 0μA		2.0	20	40	μA

Note:

3. For a power supply of 5V ±10% the worst case output voltages (V_{OH}, and V_{OL}) occur for HC at 4.5V. Thus the 4.5V values should be used when designing with this supply. Worst case V_{IH} and V_{IL} occur at V_{CC} = 5.5V and 4.5V respectively. (The V_{IH} value at 5.5V is 3.85V.) The worst case leakage current (I_{IN}, I_{CC}, and I_{OZ}) occur for CMOS at the higher voltage and so the 6.0V values should be used.

AC Electrical Characteristics

V_{CC} = 5V, T_A = 25°C, C_L = 15pF, t_r = t_f = 6ns

Symbol	Parameter	Conditions	Typ.	Guaranteed Limit	Units
t _{PHL} , t _{PLH}	Maximum Propagation Delay		7	13	ns

AC Electrical Characteristics

$V_{CC} = 2.0V$ to $6.0V$, $C_L = 50pF$, $t_r = t_f = 6ns$ (unless otherwise specified)

Symbol	Parameter	Conditions	V _{CC} (V)	T _A =25°C		T _A =−40°C to 85°C	T _A −55°C to 125°C	
				Typ.	Guaranteed Limits			
t _{PHL} , t _{PLH}	Maximum Propagation Delay		2.0	49	82	103	120	ns
			4.5	9.9	16	21	24	
			6.0	8.4	14	18	20	
t _{TLH} , t _{THL}	Maximum Output Rise and Fall Time		2.0	30	75	95	110	ns
			4.5	8	15	19	22	
			6.0	7	13	16	19	
C _{PD}	Power Dissipation Capacitance ⁽⁴⁾	(per gate)		90				pF
C _{IN}	Maximum Input Capacitance			8	15	15	15	pF

Note:

4. C_{PD} determines the no load dynamic power consumption, $P_D = C_{PD} V_{CC}^2 f + I_{CC} V_{CC}$, and the no load dynamic current consumption, $I_S = C_{PD} V_{CC} f + I_{CC}$.

Typical Applications

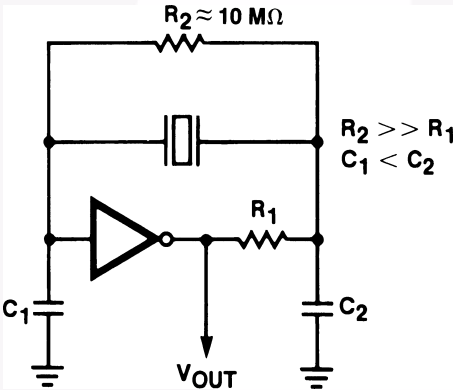


Figure 1. Crystal Oscillator

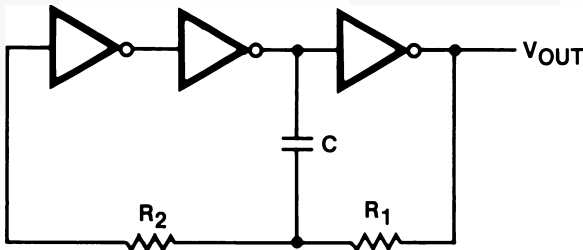


Figure 2. Stable RC Oscillator

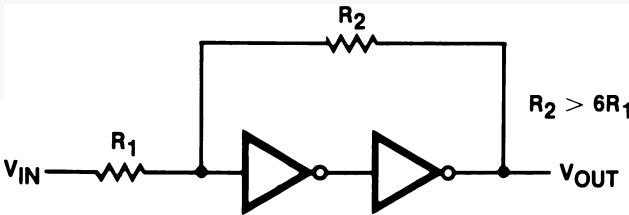
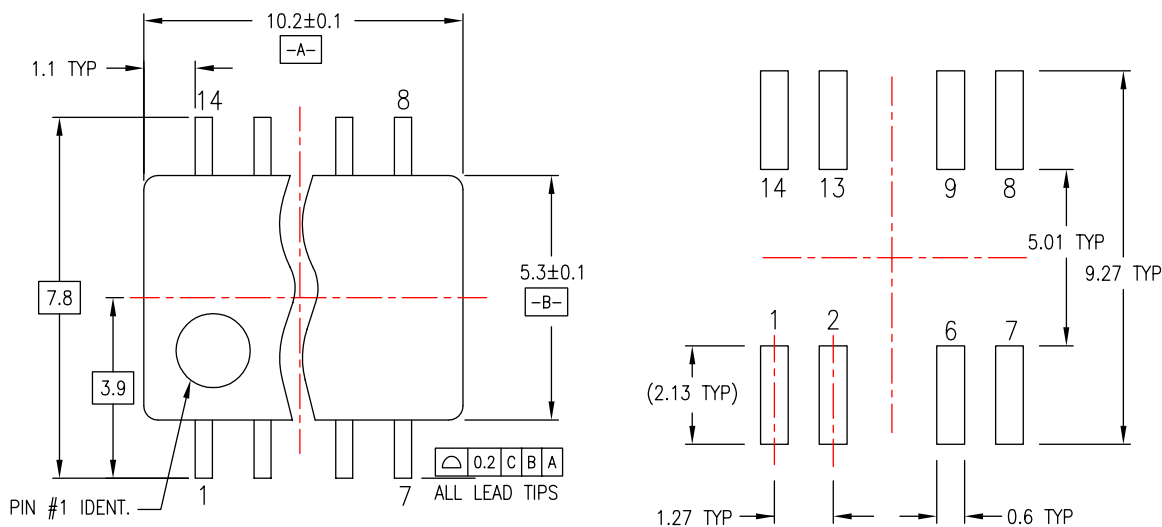
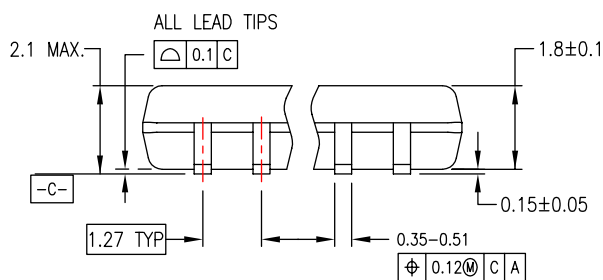


Figure 3. Schmitt Trigger

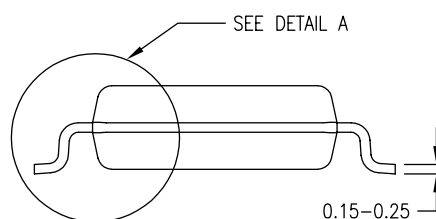
Physical Dimensions (Continued)



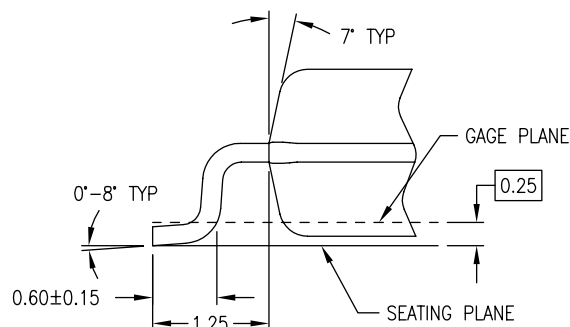
LAND PATTERN RECOMMENDATION



DIMENSIONS ARE IN MILLIMETERS



7° TYP



DETAIL A

NOTES:

- A. CONFORMS TO EIAJ EDR-7320 REGISTRATION, ESTABLISHED IN DECEMBER, 1998.
- B. DIMENSIONS ARE IN MILLIMETERS.
- C. DIMENSIONS ARE EXCLUSIVE OF BURRS, MOLD FLASH, AND TIE BAR EXTRUSIONS.

M14DREVC

Figure 5. 14-Lead Small Outline Package (SOP), EIAJ TYPE II, 5.3mm Wide

Package drawings are provided as a service to customers considering Fairchild components. Drawings may change in any manner without notice. Please note the revision and/or date on the drawing and contact a Fairchild Semiconductor representative to verify or obtain the most recent revision. Package specifications do not expand the terms of Fairchild's worldwide terms and conditions, specifically the warranty therein, which covers Fairchild products.

Always visit Fairchild Semiconductor's online packaging area for the most recent package drawings:

<http://www.fairchildsemi.com/packaging/>

Physical Dimensions (Continued)



NOTES:

- A. CONFORMS TO JEDEC REGISTRATION MO-153, VARIATION AB, REF NOTE 6
- B. DIMENSIONS ARE IN MILLIMETERS
- C. DIMENSIONS ARE EXCLUSIVE OF BURRS, MOLD FLASH, AND TIE BAR EXTRUSIONS
- D. DIMENSIONING AND TOLERANCES PER ANSI Y14.5M, 1982
- E. LANDPATTERN STANDARD: SOP65P640X110-14M
- F. DRAWING FILE NAME: MTC14REV6

Figure 6. 14-Lead Thin Shrink Small Outline Package (TSSOP), JEDEC MO-153, 4.4mm Wide

Package drawings are provided as a service to customers considering Fairchild components. Drawings may change in any manner without notice. Please note the revision and/or date on the drawing and contact a Fairchild Semiconductor representative to verify or obtain the most recent revision. Package specifications do not expand the terms of Fairchild's worldwide terms and conditions, specifically the warranty therein, which covers Fairchild products.

Always visit Fairchild Semiconductor's online packaging area for the most recent package drawings:

<http://www.fairchildsemi.com/packaging/>

Physical Dimensions (Continued)**NOTES: UNLESS OTHERWISE SPECIFIED**

THIS PACKAGE CONFORMS TO

A) JEDEC MS-001 VARIATION BA

B) ALL DIMENSIONS ARE IN MILLIMETERS.

C) DIMENSIONS ARE EXCLUSIVE OF BURRS,
MOLD FLASH, AND TIE BAR EXTRUSIONS.D) DIMENSIONS AND TOLERANCES PER
ASME Y14.5-1994

E) DRAWING FILE NAME: MKT-N14AREV7

Figure 7. 14-Lead Plastic Dual-In-Line Package (PDIP), JEDEC MS-001, 0.300" Wide

Package drawings are provided as a service to customers considering Fairchild components. Drawings may change in any manner without notice. Please note the revision and/or date on the drawing and contact a Fairchild Semiconductor representative to verify or obtain the most recent revision. Package specifications do not expand the terms of Fairchild's worldwide terms and conditions, specifically the warranty therein, which covers Fairchild products.



Always visit Fairchild Semiconductor's online packaging area for the most recent package drawings:

<http://www.fairchildsemi.com/packaging/>



TRADEMARKS

The following includes registered and unregistered trademarks and service marks, owned by Fairchild Semiconductor and/or its global subsidiaries, and is not intended to be an exhaustive list of all such trademarks.

ACEx [®]	FPS [™]	PDP-SPM [™]	SupreMOS [™]
Build it Now [™]	FRFET [®]	Power220 [®]	SyncFET [™]
CorePLUS [™]	Global Power Resource SM	POWEREDGE [®]	SYSTEM [®]
CROSSVOLT [™]	Green FPS [™]	Power-SPM [™]	GENERAL
CTL [™]	Green FPS [™] e-Series [™]	PowerTrench [®]	The Power Franchise [®]
Current Transfer Logic [™]	GTO [™]	Programmable Active Droop [™]	the
EcoSPARK [®]	i-Lo [™]	QFET [®]	power [®]
EZSWITCH [™] *	IntelliMAX [™]	QS [™]	franchise
	ISOPLANAR [™]	QT Optoelectronics [™]	TinyBoost [™]
	MegaBuck [™]	Quiet Series [™]	TinyBuck [™]
Fairchild [®]	MICROCOUPLER [™]	RapidConfigure [™]	TinyLogic [®]
Fairchild Semiconductor [®]	MicroFET [™]	SMART START [™]	TINYOPTO [™]
FACT Quiet Series [™]	MicroPak [™]	SPM [®]	TinyPower [™]
FACT [®]	MillerDrive [™]	STEALTH [™]	TinyPWM [™]
FAST [®]	Motion-SPM [™]	SuperFET [™]	TinyWire [™]
FastvCore [™]	OPTOLOGIC [®]	SuperSOT [™] 3	μSerDes [™]
FlashWriter [®] *	OPTOPLANAR [®]	SuperSOT [™] 6	UHC [®]
		SuperSOT [™] 8	Ultra FRFET [™]
			UniFET [™]
			VCX [™]

* EZSWITCH[™] and FlashWriter[®] are trademarks of System General Corporation, used under license by Fairchild Semiconductor.

DISCLAIMER

FAIRCHILD SEMICONDUCTOR RESERVES THE RIGHT TO MAKE CHANGES WITHOUT FURTHER NOTICE TO ANY PRODUCTS HEREIN TO IMPROVE RELIABILITY, FUNCTION, OR DESIGN. FAIRCHILD DOES NOT ASSUME ANY LIABILITY ARISING OUT OF THE APPLICATION OR USE OF ANY PRODUCT OR CIRCUIT DESCRIBED HEREIN; NEITHER DOES IT CONVEY ANY LICENSE UNDER ITS PATENT RIGHTS, NOR THE RIGHTS OF OTHERS. THESE SPECIFICATIONS DO NOT EXPAND THE TERMS OF FAIRCHILD'S WORLDWIDE TERMS AND CONDITIONS, SPECIFICALLY THE WARRANTY THEREIN, WHICH COVERS THESE PRODUCTS.

LIFE SUPPORT POLICY

FAIRCHILD'S PRODUCTS ARE NOT AUTHORIZED FOR USE AS CRITICAL COMPONENTS IN LIFE SUPPORT DEVICES OR SYSTEMS WITHOUT THE EXPRESS WRITTEN APPROVAL OF FAIRCHILD SEMICONDUCTOR CORPORATION.

As used herein:

1. Life support devices or systems are devices or systems which, (a) are intended for surgical implant into the body or (b) support or sustain life, and (c) whose failure to perform when properly used in accordance with instructions for use provided in the labeling, can be reasonably expected to result in a significant injury of the user.
2. A critical component in any component of a life support, device, or system whose failure to perform can be reasonably expected to cause the failure of the life support device or system, or to affect its safety or effectiveness.

PRODUCT STATUS DEFINITIONS

Definition of Terms

Datasheet Identification	Product Status	Definition
Advance Information	Formative or In Design	This datasheet contains the design specifications for product development. Specifications may change in any manner without notice.
Preliminary	First Production	This datasheet contains preliminary data; supplementary data will be published at a later date. Fairchild Semiconductor reserves the right to make changes at any time without notice to improve design.
No Identification Needed	Full Production	This datasheet contains final specifications. Fairchild Semiconductor reserves the right to make changes at any time without notice to improve the design.
Obsolete	Not In Production	This datasheet contains specifications on a product that has been discontinued by Fairchild Semiconductor. The datasheet is printed for reference information only.

Rev. I33

Mouser Electronics

Authorized Distributor

Click to View Pricing, Inventory, Delivery & Lifecycle Information:

[onsemi:](#)

[MM74HCU04MTC_Q](#)